





TMAG6180-Q1 JAJSOV6A - MARCH 2023 - REVISED MARCH 2024

# TMAG6180-Q1 車載用高精度アナログ AMR 360° 角度センサ

# 1 特長

- 車載アプリケーション用に AEC-Q100 認定済み:
  - 温度グレード 0:-40℃~150℃
- 機能安全準拠
  - 機能安全アプリケーション向けに開発
  - ASIL B までの ISO 26262 システム設計を支援す るドキュメントを提供
- 高精度、小さい角度誤差の AMR センサ:
  - 0.1°(標準値)
  - 0.4° (3.3V、全温度範囲での最大値)
  - 0.56° (5.5V、全温度範囲での最大値)
- 高速 AMR 角度センサ:
  - 非常に低いレイテンシ < 2µs で最大 100krpm に 対応
- 角度ドリフトが小さいため、温度範囲全体にわたるキャ リブレーションが不要です
- 正弦波と余弦波の差動レシオメトリックアナログ出力
- 差動エンドまたはシングルエンドのアプリケーションを
- 広い動作磁界範囲:20mT~1T
- 高速起動: < 40µs
- ホール センサを使用した内蔵象限検出
  - AMR の角度範囲を 360° まで拡大
  - 速度と方向に使用可能
  - オープンドレインデジタル出力
- 電源電圧範囲:2.7V~5.5V

# 2 アプリケーション

- 電動パワー・ステアリング
- 操舵角センサ
- BLDC/PMSM モーター位置検出
- 電動アシスト自転車
- ワイパー・モジュール
- アクチュエータ
- サーボ・ドライブ位置センサ
- トラクション・モーター

# 3 概要

TMAG6180-Q1 は、Anisotropic Magneto Resistive (AMR) テクノロジーをベースとする高精度角度センサで す。このデバイスには、信号コンディショニングアンプが内 蔵されており、印加される面内磁界の方向に関連する、正 弦波と余弦の差動アナログ出力を提供します。このデバイ スは X 軸と Y 軸に 2 つの独立したホール センサ出力も 備えており、センサの角度範囲を 360° まで拡大するため に使用できます。

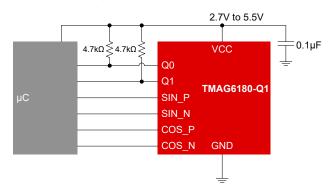
TMAG6180-Q1 は、柔軟な機械的配置が可能な広い動 作磁界と、回転子位置検出などの高速アプリケーションに 適した低レイテンシ (1.6µs) 出力を特長としています。こ のデバイスは、正弦波出力と余弦出力のレイテンシが非 常に短いため、レイテンシに関連する角度誤差を最小限 に抑えることができ、最大 100krpm の回転子位置検出な どの高速アプリケーションのために設計されています。

TMAG6180-Q1 は、車載と産業用の厳格な機能安全要 件に対応するための広範な診断機能を備えています。こ のデバイスは、-40℃~+150℃の広い周囲温度範囲で一 貫した動作を行い、熱ドリフトと寿命誤差を最小限に抑え ます。

### パッケージ情報

部品番号	パッケージ <sup>(1)</sup>	パッケージ サイズ <sup>(2)</sup>
TMAG6180-Q1	DGK (VSSOP, 8)	3mm × 4.9mm

- 詳細については、セクション 10 を参照してください。
- パッケージ サイズ (長さ×幅) は公称値であり、該当する場合はピ ンも含まれます。



アプリケーション ブロック図



# **Table of Contents**

1	特長	. 1
2	アプリケーション	1
	概要	
4	Pin Configuration and Functions	.3
	Specifications	
	5.1 Absolute Maximum Ratings	
	5.2 ESD Ratings	
	5.3 Recommended Operating Conditions	
	5.4 Thermal Information	
	5.5 Electrical Characteristics	5
	5.6 Magnetic Characteristics	.6
	5.7 Typical Characteristics	.7
6	Detailed Description	.8
	6.1 Overview	
	6.2 Functional Block Diagram	
	6.3 Feature Description	

6.4 Device Functional Modes	21
7 Application and Implementation	
7.1 Application Information	
7.2 Typical Application	
7.3 Power Supply Recommendations	
7.4 Layout	29
8 Device and Documentation Support	
8.1ドキュメントの更新通知を受け取る方法	30
8.2 サポート・リソース	30
8.3 Trademarks	30
8.4 静電気放電に関する注意事項	
8.5 用語集	30
9 Revision History	
10 Mechanical, Packaging, and Orderable	
Information	30

Product Folder Links: TMAG6180-Q1

English Data Sheet: SLYS037



# **4 Pin Configuration and Functions**

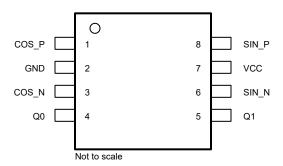


図 4-1. DGK Package 8-Pin VSSOP Top View

表 4-1. Pin Functions

F	PIN		PIN TYPE <sup>(1)</sup>		DESCRIPTION
NO.	NAME	IIFE( /	DESCRIPTION		
1	COS_P	0	Differential cosine output (positive)		
2	GND	G	Ground reference		
3	COS_N	0	oifferential cosine output (negative)		
4	Q0	0	uadrature 0 digital output (open drain)		
5	Q1	0	Quadrature 1 digital output (open drain)		
6	SIN_N	0	Differential sine output (negative)		
7	VCC	Р	Power supply		
8	SIN_P	0	Differential sine output (positive)		

<sup>(1)</sup> I = input, O = output, I/O = input and output, G = ground, P = power

3



# **5 Specifications**

# 5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

		MIN	MAX	UNIT
V <sub>CC</sub>	Main supply voltage	-0.3	7	V
I <sub>OUT</sub>	Output current (SIN_P, SIN_N, COS_P, COS_N, Q1, Q0)	-10	10	mA
V <sub>OUT</sub>	Output voltage (SIN_P, SIN_N, COS_P, COS_N, Q1 ,Q0)	-0.3	7	V
TJ	Junction temperature	-40	170	°C
T <sub>stg</sub>	Storage temperature	-65	150	°C

<sup>(1)</sup> Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute maximum ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If briefly operating outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not sustain damage, but it may not be fully functional. Operating the device in this manner may affect device reliability, functionality, performance, and shorten the device lifetime.

# 5.2 ESD Ratings

				VALUE	UNIT
		Human body model (HBM), per AEC Q100-002 <sup>(1)</sup> HBM ESD classification level 2	±2000		
V <sub>(ESD)</sub>		Charged device model (CDM), per	All pins	±500	V
		AEC Q100-011 CDM ESD classification level C4B	Corner pins (1, 4, 5, and 8)	±750	

<sup>(1)</sup> AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.

# **5.3 Recommended Operating Conditions**

over operating free-air temperature range (unless otherwise noted)

資料に関するフィードバック(ご意見やお問い合わせ)を送信

		MIN	NOM MAX	UNIT
V <sub>CC</sub>	Main supply voltage	2.7	5.5	V
T <sub>A</sub>	Operating free air temperature	-40	150	С
C <sub>L</sub>	Capacitive load on SIN_P, SIN_N, COS_P, COS_N	0.1	10	nF
IL	Current load on SIN_P, SIN_N, COS_P, COS_N	-1	1	mA
В	Magnetic flux density for AMR saturation	20		mT

### **5.4 Thermal Information**

		TMAG6180-Q1	
	THERMAL METRIC <sup>(1)</sup>	DGK (VSSOP)	UNIT
		8 PINS	
R <sub>0JA</sub>	Junction-to-ambient thermal resistance	166.8	°C/W
R <sub>0JC(top)</sub>	Junction-to-case (top) thermal resistance	57.8	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	88.7	°C/W
$\Psi_{JT}$	Junction-to-top characterization parameter	7.0	°C/W
$\Psi_{JB}$	Junction-to-board characterization parameter	87.1	°C/W

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.



# **5.5 Electrical Characteristics**

over operating free-air temperature range (unless otherwise noted); typical specifications are at  $T_A$  = 25°C

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
AMR Output P	Parameters					
V <sub>out</sub>	Single-ended output voltage peak to peak	V <sub>CC</sub> = 3.3V	57	62	67.5	%V <sub>CC</sub>
Single-ended output voltage peak to peak		V <sub>CC</sub> = 5.5V	55	60	65	%V <sub>CC</sub>
k	Amplitude asynchronism ratio (Vpk	B = 30mT, V <sub>CC</sub> = 3.3V	-2.3	0.3	2.3	%
k	Cos/ Vpk Vsin)	B = 30mT, V <sub>CC</sub> = 5V	-2.4	0.3	2.4	%
V	Differential offset of SIN/COS outputs	B = 30mT, T <sub>A</sub> = 25°C, V <sub>CC</sub> = 3.3V	-56		56	mV
V <sub>offset_room</sub>	at room	B = 30mT, $T_A = 25^{\circ}C$ , $V_{CC} = 5V$	-90		90	mV
V <sub>offset tc</sub>	Temperature coefficient of differential offset voltage	B = 30mT, V <sub>CC</sub> = 3.3V		±0.1		mV/°C
_	onset voltage	B = 30mT, V <sub>CC</sub> = 5V		±0.1		mV/°C
V	Common mode output voltage	B = 30mT, V <sub>CC</sub> = 3.3V	48	50	52	%VCC
V <sub>CM</sub>	Common-mode output voltage	B = 30mT, V <sub>CC</sub> = 5V	48	50	52	%VCC
V <sub>NOISE</sub>	Output referred noise (differential)	B = 30mT, C <sub>load</sub> = 100pF		0.5		$mV_{rms}$
R <sub>out</sub>	Series output resistance			55		Ω
t <sub>agc_update</sub>	Update rate of the automatic gain control	After V <sub>out</sub> reaching 60% of V <sub>CC</sub>		1		s
DC Power	,		1			
V <sub>CC_UV</sub>	VCC undervoltage threshold			2.45	2.65	V
V <sub>CC_OV</sub>	VCC overvoltage threshold			5.9	6.36	V
VCC <sub>RAMP</sub>	Power supply ramp rate for proper device start-up	V <sub>CC</sub> = 10% to 90% Specified by design			0.2	ms
I <sub>ACT</sub>	Active mode current from VCC			6.5	10	mA
t <sub>on_startup</sub>	Power-on time during start-up	To achieve 90% of output voltages after VCC has reached final value (C <sub>LOAD</sub> =100pF)		38	85	μs
Digital I/O						
$V_{OL_Q}$	Low level output voltage	I <sub>O</sub> = 1mA on Q0, Q1 pins	0		0.4	V
Hall sensor ou	utputs		•			
tpd	Propagation delay time per channel	Change in B <sub>OP</sub> or B <sub>RP</sub> to change in output		10		μs

資料に関するフィードバック(ご意見やお問い合わせ)を送信

5



# **5.6 Magnetic Characteristics**

over operating free-air temperature range (unless otherwise noted); typical specifications are at  $T_A = 25$ °C

	PARAMETER	TEST CONDITIONS	MIN TYP	MAX	UNIT
Angular Performa	nce				
ANG	Angular error linearity across temperature on continuous calibration	B = 30mT, V <sub>CC</sub> = 3.3V, Magnetic field Rotation Speed = 1000rpm	0.1	0.35	deg
ANG <sub>ERR_DYN</sub> _SE	(gain / offset) (single ended)	B = 30mT, V <sub>CC</sub> = 5V, Magnetic field Rotation Speed = 1000rpm	0.1	0.56	deg
ANG <sub>ERR_DYN_DE</sub>	Angular error linearity across temperature on continuous calibration	B = 30mT, $V_{CC}$ = 3.3V, Magnetic field Rotation Speed = 1000rpm	0.1	0.4	deg
/ CERR_DYN_DE	(gain / offset) (differential ended)	B = 30mT, $V_{CC}$ = 5V, Magnetic field Rotation Speed = 1000rpm	0.1	0.56	deg
ANG <sub>ERR_RTCAL_SE</sub>	Angular error linearity across temperature after room temperature	B = 30mT, $V_{CC}$ = 3.3V, Ideal magnet alignment	0.1	1.1	deg
7VOERK_RTOAL_SE	calibration (of offset / gain mismatch) (single ended)	B = 30mT, V <sub>CC</sub> = 5V, Ideal magnet alignment	0.1	1.1	deg
ANG <sub>ERR_RTCAL_DE</sub>	Angular error linearity across temperature after room temperature	B = 30mT, $V_{CC}$ = 3.3V, Ideal magnet alignment	0.2	2 1.0	deg
····~ERN_RICAL_DE	calibration (of offset / gain mismatch) (differential ended)	B = 30mT, $V_{CC}$ = 5V, Ideal magnet alignment	0.1	0.95	deg
ANG <sub>ERR_NOCAL_SE</sub>	Angular error linearity across temperature with no calibration of	B = 30mT, $V_{CC}$ = 3.3V, Ideal magnet alignment	0.5	1.52	deg
7VERR_NOCAL_SE	gain / offset (single ended)	B = 30mT, $V_{CC}$ = 5V, Ideal magnet alignment	0.5	1.26	deg
ANG <sub>ERR_NOCAL_DE</sub>	Angular error linearity across temperature with no calibration of	B = 30mT, V <sub>CC</sub> = 3.3V, Ideal magnet alignment	0.4	1.1	deg
7 OERR_NOCAL_DE	gain / offset (differential ended)	B = 30mT, $V_{CC}$ = 5V, Ideal magnet alignment	0.4	1.0	deg
ANG <sub>LT_DRIFT</sub>	Angle error lifetime drift	B = 30mT	0.05	±0.75	deg
ANG <sub>HYST</sub>	Angle hysteresis error	B = 30mT	0.01	0.06	deg
ANG <sub>OE_ERR</sub>	Orthogonality error	B = 30mT	0.01	0.051	deg
ANG <sub>NOISE</sub>	Angular RMS (1-sigma) noise in degrees	B = 30mT, C <sub>load</sub> = 100pF	0.01	0.06	deg
t <sub>del_amr</sub>	Propagation Delay time	C <sub>load</sub> = 100pF	1.6	;	μs
BW <sub>3dB_amr</sub>	3dB Bandwidth	C <sub>load</sub> = 100pF	100	)	KHz
φ <sub>err</sub>	Phase error	Magnetic Field Rotation Speed = 10000rpm, C <sub>load</sub> = 100pF	0.15	j	deg
Hall sensor chara	cteristics				
$B_{OP(X)}, B_{OP(Y)}$	Magnetic field operating point		3	3	mT
$B_{RP(X)}, B_{RP(Y)}$	Magnetic field release point		-3	3	mT
B <sub>OP</sub> - B <sub>RP</sub>	Magnetic hysteresis		3.5	3	mT
B <sub>SYM_OP</sub>	Operating point symmetry	Bop(x) – Bop(y)	±0.5	j	mT
B <sub>SYM_RP</sub>	Release point symmetry	Brp(x) - Brp(y)	±0.5	j	mT
B <sub>SYM_RP</sub>	Release point symmetry	Brp(x) - Brp(y)	C	)	mT
t <sub>PD_HALL</sub>	Propagation delay time per channel	Change in B <sub>OP</sub> or B <sub>RP</sub> to change in output	10	)	μs

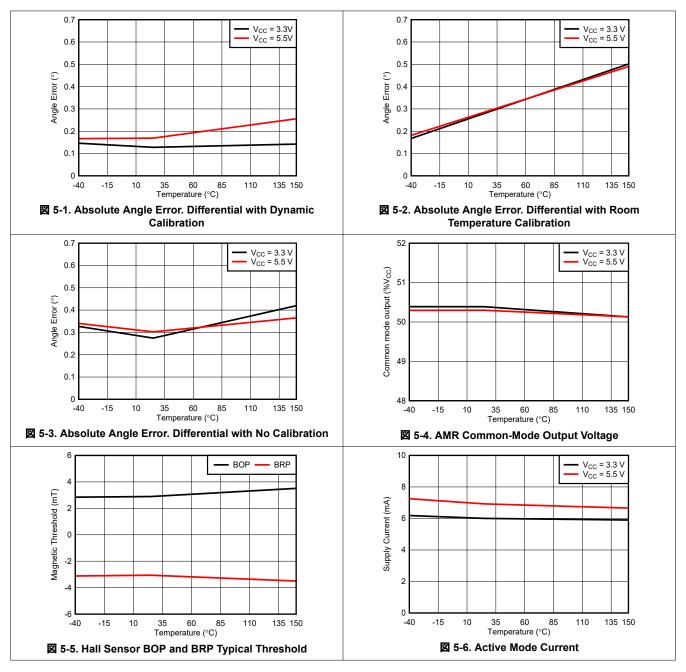
資料に関するフィードバック (ご意見やお問い合わせ) を送信

Copyright © 2024 Texas Instruments Incorporated

۵



# 5.7 Typical Characteristics



# **6 Detailed Description**

### 6.1 Overview

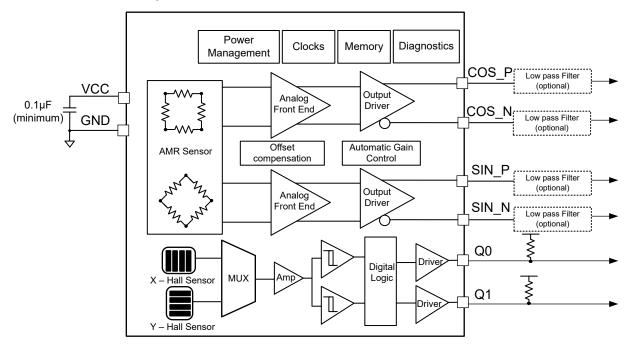
The TMAG6180-Q1 is a high-precision angle sensor based on the AMR sensor technology vertically integrated on top of the integrated amplifiers on silicon. The differential output sine and cosine signals from the AMR sensor are proportional to the angle of the applied magnetic field. The sine and cosine signals are internally signal conditioned, temperature compensated, and driven by differential output amplifiers with the ability to drive large capacitive loads. The output voltages of the AMR sensor are ratiometric to the supply voltage, therefore the external ADC can use the supply voltage as a reference.

TMAG6180-Q1 integrates X and Y Hall sensors to provide quadrature outputs on pins Q0 and Q1, respectively. The Hall effect sensors are chopper stabilized, signal conditioned, and multiplexed to provide two digital latched outputs. These outputs can be used to extend the angle sensing range of the AMR sensor from 180 degrees to 360 degrees.

The TMAG6180-Q1 contains the following functional and building blocks:

- The Power Management and Oscillators block contains internal regulators, biasing circuitry, a low-frequency, wake-up oscillator and a high-frequency, wake-up oscillator, overvoltage detection circuitry, and undervoltage detection circuitry
- The AMR sensor contains two Wheatstone bridges made of magnetic resistive sensors, each sensing one of the components of the applied magnetic field, the sine and the cosine components.
- The AMR sensing path contains the signal conditioning amplifiers, offset compensation, automatic gain control circuitry and the output drivers.
- The Quadrature Detection Path contains the X and Y Hall sensors, related biasing circuitry, signal conditioning, logic comparators and digital logic to drive the Q1 and Q0 outputs
- The Internal memory block supports the factory-programmed values
- The diagnostic blocks support background diagnostic checks of the internal circuitry

# 6.2 Functional Block Diagram



Copyright © 2024 Texas Instruments Incorporated



# **6.3 Feature Description**

# **6.3.1 Magnetic Flux Direction**

The TMAG6180-Q1 is sensitive to the magnetic field component in X and Y directions. The X and Y fields are inplane with the package. The device generates sine and cosine outputs from the AMR based on the reference position (0°). See <u>Direction of Sensitivity</u>.

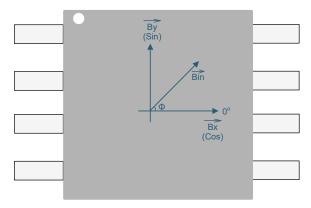


図 6-1. Direction of Sensitivity

9



### **6.3.2 Sensors Location and Placement Tolerances**

Location of AMR Sensor and Hall Elements shows the location of the AMR sensor and X, Y Hall elements, along with the placement tolerances inside the TMAG6180-Q1.

# Centered ± 25 μm SIDE VIEW 0.24 mm ± 0.065 mm

図 6-2. Location of AMR Sensor and Hall Elements

The center of the AMR and Hall sensors lie in the center of the package. Die Rotation Tolerances in the Package shows the tolerances of the die rotation within the package. This causes a reference angle error  $(\Phi)$  of  $\pm 3^{\circ}$ .

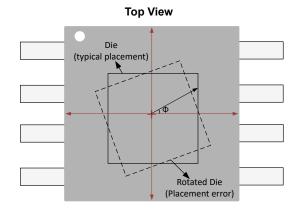


図 6-3. Die Rotation Tolerances in the Package

資料に関するフィードバック(ご意見やお問い合わせ) を送信

Copyright © 2024 Texas Instruments Incorporated

# 6.3.3 Magnetic Response

$$\theta = \frac{\arctan 2\left(\frac{V\sin}{V\cos}\right)}{2} \tag{1}$$

where

- · Vsin is the differential sine output
- Vcos is the differential cosine output

The AMR sensor is sensitive only to the direction of the magnetic field and has a wide operating magnetic field range. The voltage levels of the AMR outputs are independent of the absolute flux density as long as the magnetic flux density is above the minimum recommended operating fields.

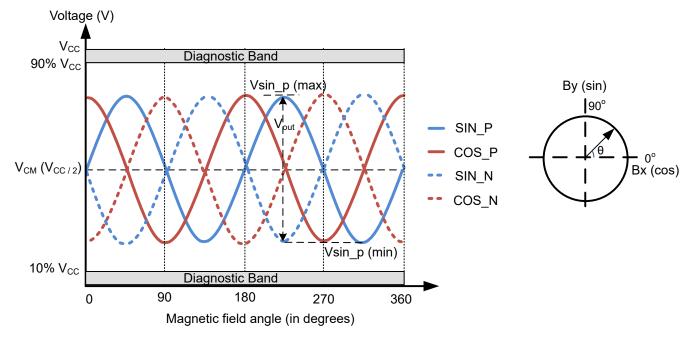


図 6-4. AMR Sensor Outputs Magnetic Response

The two integrated Hall sensors X and Y that are sensitive to the in-plane X and Y axes similar to the AMR sensor.  $\boxtimes$  6-5 shows both the Hall outputs reacting to the input field by going low when the field is higher than operating point (B<sub>OP</sub>) and going high when the field is lower than returning point (B<sub>RP</sub>).

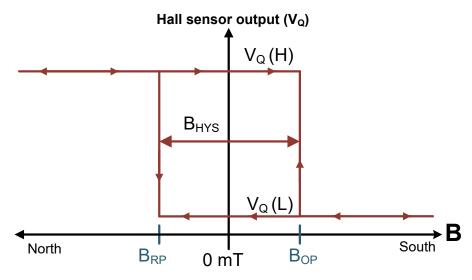
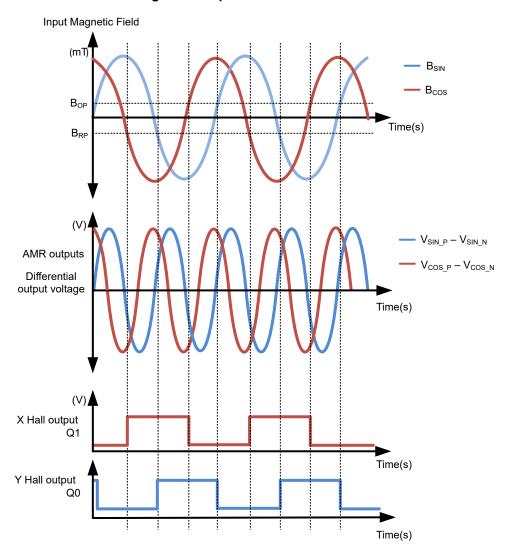


図 6-5. Hall Sensor Magnetic Response

For a rotating input magnetic field, with the X and Y components of  $B_{SIN}$  and  $B_{COS}$  respectively,  $\boxtimes$  6-6 shows the response of the AMR and Hall sensors. The integrated X and Y Hall sensors provide digital outputs (Q0 and Q1, respectively). See the *Functional Block Diagram*. The Hall sensors have a 360° compared to the 180° angle range of the AMR sensors. By utilizing the digital outputs of the Hall sensors, the angle range of the AMR sensor can be extended to 360°.

図 6-6. Magnetic Response of AMR and Hall sensors



13

### 6.3.4 Parameters Definition

### 6.3.4.1 AMR Output Parameters

The single-ended output signals SIN\_P, SIN\_N, COS\_P and COS\_N are shown in 🗵 6-4. These signals are ratiometric to the supply voltage (V<sub>CC</sub>). The common-mode voltage (V<sub>CM</sub>) of the individual signals is half of the supply voltage (V<sub>CC</sub> /2). For single-ended signals, V<sub>OUT</sub> is defined as the difference between the maximum and minimum output voltage for a rotating magnetic field. Use 式 2 to calculate V<sub>OUT SIN P</sub>.

$$V_{OUT\_SIN\_P} = V_{SIN\_P(max)} - V_{SIN\_P(min)}$$
 (2)

where

- V<sub>SIN P (min)</sub> is the minimum output voltage across the full magnetic angle range
- $V_{SIN\ P\ (max)}$  is the maximum output voltage across the full magnetic angle range

Typically, V<sub>OUT</sub> is around 60% of the supply voltage (V<sub>CC</sub>). The diagnostic band shown in AMR Sensor Outputs Magnetic Response indicates that the output signals are outside normal operating range and indicates a presence of fault.

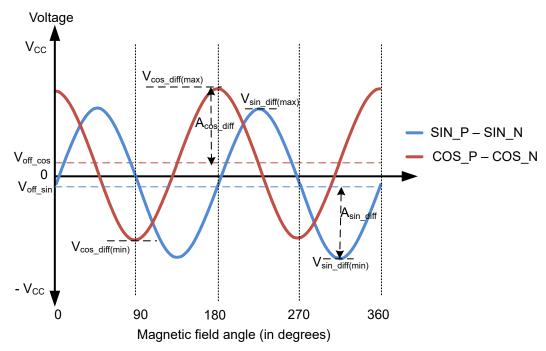


図 6-7. AMR Differential Ended Output Signals

The differential sine and cosine output signals shown in Z 6-7 are generated from the corresponding sine and cosine single-ended outputs. Use 式 3 and 式 4 to calculate the differential voltages.

$$V_{sin diff} = V_{SIN P} - V_{SIN N}$$
(3)

$$V_{\cos diff} = V_{\cos P} - V_{\cos N}$$
 (4)

The offset of the differential signals is the average of the maximum and minimum voltages of the sine or cosine signals. Use  $\pm 5$  and  $\pm 6$  to calculate the offsets for the sine and cosine signals.

$$V_{\text{offset\_sin}} = \frac{V_{\text{sin\_diff}(\text{max})} + V_{\text{sin\_diff}(\text{min})}}{2}$$
 (5)

$$V_{\text{offset\_cos}} = \frac{V_{\text{cos\_diff}(\text{max})} + V_{\text{cos\_diff}(\text{min})}}{2}$$
 (6)

For single-ended signals, the offset is the common-mode voltage (V<sub>CM</sub>).

Use  $\pm$  7 to calculate the differential offset for sine and cosine channels at any given temperature,  $T_A$ .

$$V_{\text{offset}} = V_{\text{offset, room}} \times (1 + V_{\text{offset, TC}} \times (T_{\text{A}} - 25^{\text{o}}\text{C}))$$
(7)

where

- V<sub>Offset TC</sub> is the temperature drift coefficient of the offset
- V<sub>Offset room</sub> is the room temperature offset

Use  $\pm$  8 and  $\pm$  9 to calculate the amplitudes of the differential signals.

$$A_{\sin\_diff} = \frac{V_{\sin\_diff(max)} - V_{\sin\_diff(min)}}{2}$$
(8)

$$A_{\cos_{diff}} = \frac{V_{\cos_{diff}(max)} - V_{\cos_{diff}(min)}}{2}$$
 (9)

Use  $\pm$  10 to calculate the amplitude for single-ended signals.

$$A_{\sin_p} = \frac{V_{\sin_p(\max)} - V_{\sin_p(\min)}}{2} \tag{10}$$

Amplitude asynchronism refers to the amplitude mismatch error between sine and cosine channels. Use  $\gtrsim$  11 to calculate the amplitude mismatch error.

$$k = 1 - \left(\frac{A_{\cos\_diff}}{A_{\sin diff}}\right) \tag{11}$$

The sine and cosine output signals are typically out-of-phase by 90 degrees. However, the sine and cosine outputs from the sensor can be different than the ideal 90 degrees if an internal phase error occurs owing to sensor and other on chip circuitry non-idealities. This error is referred to as the orthogonality error. This error is defined as the angle error between the zero crossing of the cosine output and maximum value of the sine outputs.

The hysteresis error (ANG<sub>hyst</sub>) refers to the largest angle error difference between a clockwise rotation and a counter-clockwise rotation.

For the AMR sensor, the orthogonality error and the hysteresis errors are negligible.

English Data Sheet: SLYS037

### 6.3.4.2 Transient Parameters

Propagation delay  $(t_{del\_amr})$  is defined as the time taken for signal to propagate from magnetic input change to the sine and cosine AMR outputs. The bandwidth limitation of the internal signal conditioning amplifiers causes a phase shift on the applied magnetic field. The propagation delay increases based on the speed of the rotating field and is specified at the maximum speed of the recommended magnetic field.  $\boxtimes$  6-8shows an input rotating magnetic field and the response of the AMR outputs. The propagation delay in the signal path leads to a phase error.

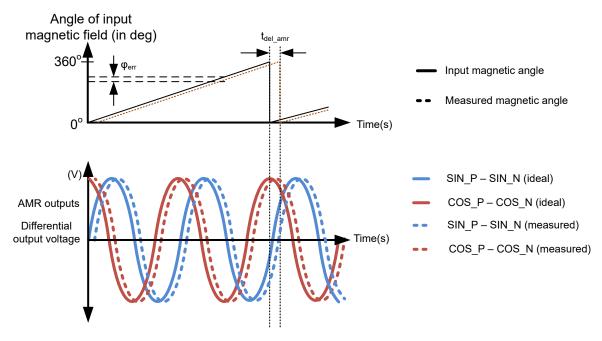


図 6-8. AMR Output Propagation Delay and Phase Error

The phase error  $(\phi_{err})$  refers to the angle error between the input magnetic field and output of the sensor. This error increases with the speed of the rotating magnetic field and the propagation delay of the AMR sensor. Typically, this error can be compensated to the first order if the speed of the rotating magnetic field is known.

Product Folder Links: TMAG6180-Q1

資料に関するフィードバック(ご意見やお問い合わせ) を送信

Copyright © 2024 Texas Instruments Incorporated

### 6.3.4.2.1 Power-On Time

The power-on time during start-up ( $T_{on\_startup}$ ) is defined as the time it takes for the AMR outputs to reach to 90% of their final value (under a constant magnetic field) after the  $V_{CC}$  reaches  $V_{CC(min)}$ .  $\boxtimes$  6-9 shows the power-on time of the device during a  $V_{CC}$  ramp.

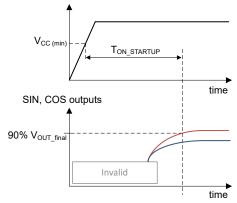


図 6-9. Power-On Time During Start-Up

### 6.3.4.3 Angle Accuracy Parameters

The overall angle error represents the relative angular error. セクション 6.3.4.3 shows the deviation from the reference line after zero angle definition..

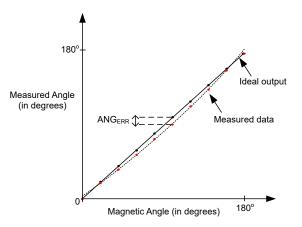


図 6-10. Angle Error

The uncalibrated angular error (ANG<sub>ERR\_NOCAL\_DE</sub>) is defined as the maximum deviation from an ideal angle without any offset and amplitude mismatch calibration for the VSIN and VCOS differential signals. For single-ended signals, the uncalibrated angular error is denoted by  $ANG_{ERR_NOCAL_SE}$ .

The single point calibration angular error ( $ANG_{ERR\_RTCAL\_DE}$ ) is defined as the maximum deviation from an ideal angle after the offset calibration is applied to the VSIN and VCOS differential signals at room temperature (25°C). For single-ended signals, the room-temperature calibrated angular error is denoted by  $ANG_{ERR\_RTCAL\_SE}$ .

The dynamic angular error (ANG<sub>ERR\_DYN</sub>) is defined as the maximum deviation from an ideal angle with the continuous offset and gain calibration applied to the VSIN and VCOS differential signals. The error is measured at 1krpm and includes the phase error owing to the propagation delay of the AMR outputs.

Copyright © 2024 Texas Instruments Incorporated

資料に関するフィードバック(ご意見やお問い合わせ)を送信

17



### 6.3.4.4 Hall Sensor Parameters

The Hall sensors X and Y have factory-calibrated operating ( $B_{OP}$ ) and release points ( $B_{RP}$ ). The operating and release points shown in  $\boxtimes$  6-4 give the magnetic hysteresis for each Hall sensor.

Use  $\pm$  12 and  $\pm$  13 to calculate the symmetry point for each axis.

$$B_{SYM(X)} = B_{OP(X)} + B_{RP(X)}$$

$$\tag{12}$$

### where

•  $B_{OP(X)}$  and  $B_{RP(X)}$  represent the operating and release points for X Hall sensor

$$B_{SYM(Y)} = B_{OP(Y)} + B_{RP(Y)}$$

$$\tag{13}$$

### where

B<sub>OP (Y)</sub> and B<sub>RP (Y)</sub> represent the operating and release points for Y Hall sensor

Use  $\pm$  14 to calculate the operating point symmetry.

$$B_{SYM OP} = B_{OP(X)} - B_{OP(Y)}$$

$$\tag{14}$$

Use 式 15 to calculate the release point symmetry.

$$B_{SYM\_RP} = B_{RP(X)} - B_{RP(Y)}$$
(15)



### 6.3.5 Automatic Gain Control (AGC)

The TMAG6180-Q1 features an automatic gain control circuitry to reduce the drift of the AMR sensor outputs across temperature. The device changes the gain of the output drivers to keep the final output within an appropriate voltage range on SIN\_P, SIN\_N, COS\_P and COS\_N. The AGC block uses the square root of the sum of the squared amplitudes of the two channels to sense amplitude of output signals and set gain selection. The AGC block sets the gain for sine and cosine channels, meaning that the peak-to-peak amplitude of single-ended voltages, V<sub>OUT</sub> is within the range listed in *Specifications*. The AGC block changes the gain of both the sine and cosine channels simultaneously.

If the outputs are out of the normal operating range, the AGC block changes the gain of the sine and cosine channels by a step size of  $\pm 1\%$  V<sub>CC</sub> at an interval of  $t_{agc\_update}$ , typically around 1 second, as defined in *Specifications*.  $\boxtimes$  6-11 shows the differential AMR outputs for a continuously rotating input field. The shaded area represents the *No AGC Control* band that represents  $\pm 5\%$  of V<sub>CC</sub> and is centered at 60% of V<sub>CC</sub>. Notice that the AGC loop reduces the gain and updates the amplitude at a step size of 1% V<sub>CC</sub> as the sine and cosine signals drift outside of the shaded region. If the outputs remain within the shaded region, then no action is taken by the AGC control loop.

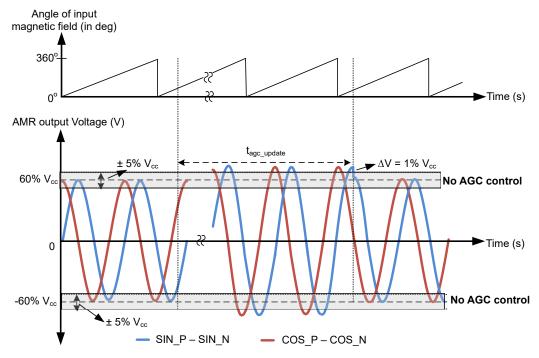


図 6-11. Timing Diagram Showing the Operation of Automatic Gain Control

19



# 6.3.6 Safety and Diagnostics

The TMAG6180-Q1 supports several device and system level diagnostics features to detect, monitor, and report failures during the device operation.

In the event of a failure, the TMAG6180-Q1 is placed in a FAULT state, where the outputs from the AMR sensors are placed in a high-impedance state. As shown in the *Application and Implementation* section, users can add pullup or pulldown resistors on SIN\_P, SIN\_N, COS\_P, COS\_N pins at the termination site (that is the microcontroller). The resistors are generally pulled up to supply voltage or pulled down to ground such that the ADC code on MCU is out of expected range. This state signal faults to the microcontroller.

In the fault state, the digital outputs Q0 and Q1 are not driven internally by the device.

The TMAG6180-Q1 performs the following device and system level checks:

### 6.3.6.1 Device Level Checks

- · AMR signal path checks
  - AMR sensor bias check
  - AMR output signals common-mode check
  - Automatic gain control loop check
- Hall sensor signal path checks
  - Hall sensor bias and resistance check
  - Hall sensor comparator check
- · Power management and supporting circuitry checks
  - Internal LDO undervoltage check
  - Internal clocks integrity check
- Internal memory integrity check (or a cyclic redundancy check–CRC)

### 6.3.6.2 System Level Checks

- V<sub>CC</sub> undervoltage and overvoltage check
- Pin level opens and short checks

*資料に関するフィードバック (ご意見やお問い合わせ) を送信*Product Folder Links: *TMAG6180-Q1* 

### **6.4 Device Functional Modes**

### 6.4.1 Operating Modes

The TMAG6180-Q1 has primarily one mode of operation when all the conditions in the *Recommended Operating Conditions* are met. When the part detects an internal fault, the device switches into a fault mode (safe state). ⊠ 6-12 shows the state transition for TMAG6180-Q1.

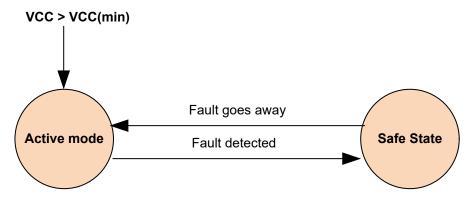


図 6-12. TMAG6180-Q1 State Transition Diagram

### 6.4.1.1 Active Mode

The device starts powering up after the  $V_{CC}$  supply crosses the minimum threshold as specified in the *Recommended Operating Conditions* table. The TMAG6180-Q1 enters the active mode, in which the SIN\_P, SIN\_N, COS\_P and COS\_N outputs actively provide the angle of the applied magnetic field. The average current consumption during the active conversion is  $I_{ACT}$ .

### 6.4.1.2 Fault Mode

The TMAG6180-Q1 supports extensive fault diagnostics as detailed in the *Diagnostics* section. When a fault is detected, the part enters the fault mode. In this mode, the AMR outputs and the Q0 and Q1 Hall outputs are placed in a high-impedance state.

21



# 7 Application and Implementation

注

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

# 7.1 Application Information

### 7.1.1 Power Supply as the Reference for External ADC

The AMR output signals of the TMAG6180-Q1 are ratiometric to the supply voltage,  $V_{CC}$ . This enables the external ADC to use the TMAG6180-Q1 supply voltage as a reference and eliminate the errors which can arise if a separate reference voltage is used. This also enables the optimization of the external ADC input range. TI therefore recommends to use the supply voltage ( $V_{CC}$ ) as the reference for the external ADCs. TI also recommends using a  $0.1\mu F$  bypass capacitor to minimize the noise on the power supply.

# 7.1.2 AMR Output Dependence on Airgap Distance

The AMR sensor is only sensitive to the direction of the applied magnetic field along the X-Y plane parallel to the chip surface. The applied magnetic field from a rotating magnet can vary based on the airgap distance between the TMAG6180-Q1 and the magnet.

As long the absolute magnetic field is above the minimum field listed in *Recommended Operating Conditions*, the angle accuracy from the AMR outputs are independent of the value of the applied magnetic field.

かせ) を送信 Copyright © 2024 Texas Instruments Incorporated Product Folder Links: *TMAG6180-Q1* 

### 7.1.3 Calibration of Sensor Errors

The TMAG6180-Q1 is factory-calibrated for best angular accuracy. Some of the electrical errors from the sensor that impact the angle accuracy can be calibrated out for achieving the best performance. 

7-1 shows the impact of the different sensor error parameters such as offset, amplitude mismatch and orthogonality error on the angle accuracy.

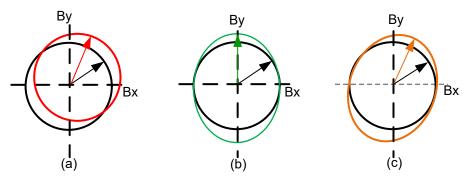


図 7-1. Angle Accuracy Impact Owing to Sensor Electrical Errors (a) Offset Error (b) Amplitude Mismatch Error (c) Orthogonality Error

Based on the parameters defined in *AMR Output Parameters*, use 式 16 to calculate the angle from the AMR sensors.

$$\theta = \frac{\arctan 2\left(\frac{A_{\sin}\sin(2\theta) + V_{\text{offset\_sin}}}{A_{\cos}\cos(2\theta) + V_{\text{offset\_cos}}}\right)}{2}$$
(16)

where

- V<sub>offset sin</sub> and V<sub>offset cos</sub> are the differential offsets of the sine and cosine outputs
- A<sub>sin</sub> and A<sub>cos</sub> are the differential amplitude of the sine and cosine outputs

The impact of the angle accuracy owing to the orthogonality error and the hysteresis errors is negligible for the TMAG6180-Q1 and can be ignored.

To calibrate the offset and amplitude mismatch errors, the magnetic field rotates over the entire range and the sine and cosine outputs are sampled continuously to obtain the minimum and maximum values of the outputs.

Users can calculate the average of the minimum and maximum values of the respective outputs across the full angle range to find the offset error of the sine and cosine outputs. Use  $\pm$  17 and  $\pm$  18 to calculate the offset correction parameters for sine and cosine.

$$V_{os\_sin\_cal} = \frac{V_{sin(max)} + V_{sin(min)}}{2}$$
(17)

$$V_{os\_cos\_cal} = \frac{V_{cos(max)} + V_{cos(min)}}{2}$$
 (18)

Users can calculate the difference of the minimum and maximum values of the respective outputs across the full angle range to find the amplitude of the sine and cosine outputs. Use 式 19 to calculate the amplitude correction parameters for sine and cosine.

$$A_{corr} = 1 - \frac{V_{sin(max)} - V_{sin(min)}}{V_{cos(max)} - V_{cos(min)}}$$
(19)

Product Folder Links: TMAG6180-Q1

Copyright © 2024 Texas Instruments Incorporated

資料に関するフィードバック(ご意見やお問い合わせ)を送信

23

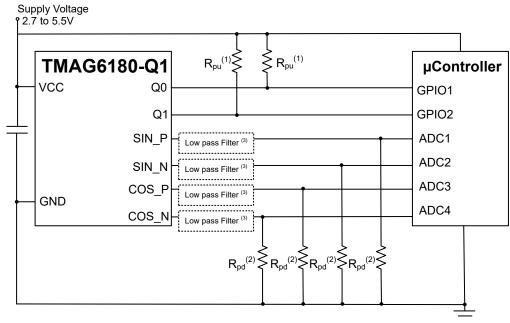


# 7.2 Typical Application

The TMAG6180-Q1 AMR angle sensor can be used either in single-ended output mode or differential output mode. The TMAG6180-Q1 has the drive capability to either drive differential or single-ended SAR or Sigma Delta ADCs. Typically, an external microcontroller processes the AMR output signals to extract the angular position.

The differential-ended output mode is helpful to eliminate any common mode disturbances in the system. 🗵 7-2 shows a typical application circuit where the differential output signals SIN P, SIN N, COS P and COS N are all connected to the four single-ended ADC channels in the external microcontroller. If differential ADC channels are available, then they are recommended. The load capacitors and resistors must match each other to achieve high accuracy. When a fault is detected, the outputs are placed in high-impedance state. TI recommends using pulldown or pullup resistors so that the external microcontroller can detect this case.

The TMAG6180-Q1 can drive capacitive loads up to 10nF directly on the AMR output pins. The device can also drive up to 100m capacitive loads through a cable with capacitances of 100pF/m. The device can drive resistive loads with the ability to source and sink currents up to 1mA.



- (1)  $50K\Omega < Rpd < 500K\Omega$  (can be left floating if unused)
- (2)  $5K\Omega < Rpu < 1M\Omega$  (can be left floating if unused)

資料に関するフィードバック(ご意見やお問い合わせ)を送信

(3) Optional RC filter to reduce noise.
Filter time constant must be lesser than on speed of rotation

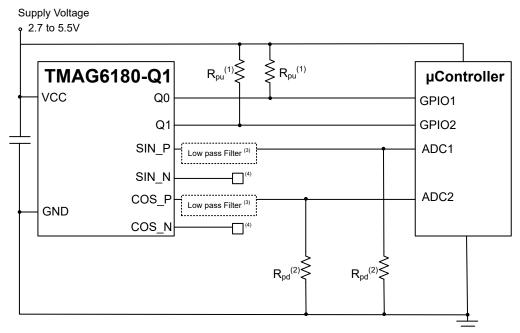
図 7-2. Application Diagram for TMAG6180-Q1 in Differential-Ended Output Mode

TI recommends using the single-ended output mode if the number of ADC ports in the microcontroller are limited, or if the number of wires from the sensor to the microcontroller must be kept to a minimum. Z 7-3 shows a typical application circuit where only the positive output channels (SIN P and COS P) are connected to singleended ADCs. The unused output signals (SIN N and COS N) can be either left floating or connected to ground through a high resistance. In single-ended output mode, the dynamic range (SNR) and noise immunity is typically reduced compared to the differential output mode. To reduce noise on the outputs and for filtering EMC disturbances, an external low-pass filter such as a first order RC network can be used. The bandwidth of the external filter must be designed based on the rotation speed of the magnetic field to be detected. TI recommends adding pullup or pulldown resistors to ground on the single-ended outputs (SIN P and COS P) so the outputs are defined when the outputs are in high-impedance state. The supply voltage of the sensor is used as the reference for the ADCs in the microcontroller.

Product Folder Links: TMAG6180-Q1

English Data Sheet: SLYS037





- (1)  $50 K\Omega$  < Rpd <  $500 K\Omega$  (can be left floating if unused) (2)  $5 K\Omega$  < Rpu <  $1 M\Omega$  (can be left floating if unused)
- (3) Optional RC filter to reduce noise.
- Filter time constant must be lesser than on speed of rotation (4) Can be left floating or connected to ground through R > 100 K $\Omega$

図 7-3. Application Diagram for TMAG6180-Q1 in Single-Ended Output Mode

# 7.2.1 Design Requirements

☑ 7-4 shows the center of the magnet aligned with the center of the sensor in a typical on-axis application.

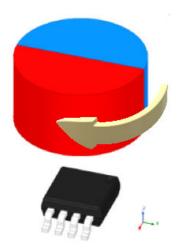


図 7-4. On axis measurement setup for TMAG6180-Q1

25

English Data Sheet: SLYS037



Use the parameters listed in 表 7-1 for this design example

表 7-1. Design Parameters

DESIGN PARAMETERS	ON-AXIS MEASUREMENT			
V <sub>CC</sub>	5V			
Magnet	Cylinder: 4.7625mm diameter, 12.7mm thick, neodymium N52, Br = 1480			
Output mode	Differential-ended			
Maximum speed of the motor	8,000 RPM			
Desired Angle error across temperature	< 1°			
Magnet to sensor placement	End of shaft			

# 7.2.2 Detailed Design Procedure

For accurate angle measurement, the center of the magnet is aligned to the center of the sensor with acceptable tolerances. Follow these steps to calibrate the sensor for best accuracy:

- Reference angle calibration Set the reference angle based on the magnet alignment to the sensor. This
  error can be saved in the microcontroller for runtime absolute position calculation. This error is also known as
  Angle offset in a system.
- Electrical offset calibration See *Calibration of Sensor Errors* for the offset calibration procedure. If the sensor cannot be rotated across the full range, then the electrical offsets cannot be calibrated.
- Amplitude mismatch calibration See Calibration of Sensor Errors for the amplitude mismatch calibration
  procedure. If the sensor cannot be rotated across the full range, then the amplitude mismatch cannot be
  calibrated.
- To extend the angle range from the AMR sensor to 360 degrees, see Extending the Angle Range to 360
   Degrees

かせ) を送信 Copyright © 2024 Texas Instruments Incorporated Product Folder Links: *TMAG6180-Q1* 



# 7.2.2.1 Extending the Angle Range to 360 Degrees

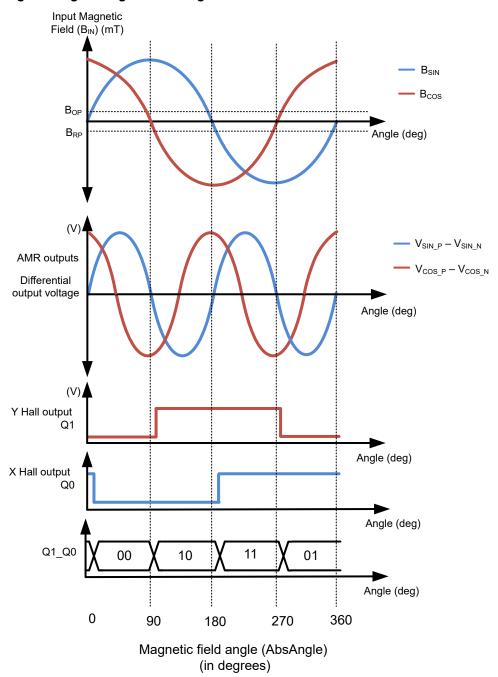


図 7-5. Magnetic Response for a 360° Input Field

 $\boxtimes$  7-5 shows the response of the differential-ended AMR output signals and the Hall outputs (Q<sub>1</sub>, Q<sub>0</sub>) for a 360° input magnetic field (B<sub>IN</sub>).

27



An example code for extending the angle range from 180 degrees to 360 degrees using the Q0, Q1 outputs is given below; MeasuredAngle = arctan2(SIN, COS)/2;  $//0-180^{\circ}$  angle range, Multiply by 180/Pi if the angle is returned in radians MeasuredAngle = 90 - MeasuredAngle // If arctan2 function returns from -90deg to 90deg angle range, then use this to convert to 0-180° angle range if (MeasuredAngle is between 45°-135°) then ( if (Q1\_Q0 is 00b or 10b) then //around 90° AbsAngle = MeasuredAngle ; else  $//Q1_Q0$  is 11b or 01b, around 270° AbsAngle = MeasuredAngle + 180°; ) else //MeasuredAngle is 0°-45° or 135°-180° ( if (Q1\_Q0 is 00b or 01b) then //around 0° if (MeasuredAngle ≥ 135°) then AbsAngle = MeasuredAngle + 180°; else //MeasuredAngle is 0-45° AbsAngle = MeasuredAngle; ) else //2Digital is 10b or 11b, around 180° if (MeasuredAngle  $\geq$  135°) then AbsAngle = MeasuredAngle; else //MeasuredAngle is 0-45°) AbsAngle = MeasuredAngle + 180°; ) )



### 7.2.3 Application Curves

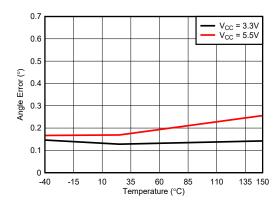


図 7-6. Angle Error with Dynamic Calibration

# 7.3 Power Supply Recommendations

A decoupling capacitor close to the device must be used to provide local energy with minimal inductance. TI recommends using a ceramic capacitor with a value of at least 0.1µF.

### 7.4 Layout

# 7.4.1 Layout Guidelines

Magnetic fields pass through most nonferromagnetic materials with no significant disturbance. Embedding magnetic sensors within plastic or aluminum enclosures and sensing magnets on the outside is common practice. Magnetic fields also easily pass through most printed circuit boards (PCBs), which makes placing the magnet on the opposite side of the PCB possible.

### 7.4.2 Layout Example

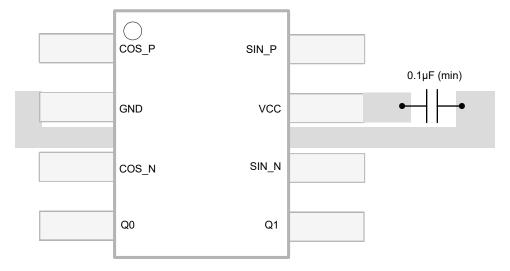


図 7-7. Layout Example With TMAG6180-Q1

29



# 8 Device and Documentation Support

# 8.1 ドキュメントの更新通知を受け取る方法

ドキュメントの更新についての通知を受け取るには、www.tij.co.jp のデバイス製品フォルダを開いてください。[通知] をクリックして登録すると、変更されたすべての製品情報に関するダイジェストを毎週受け取ることができます。 変更の詳細については、改訂されたドキュメントに含まれている改訂履歴をご覧ください。

### 8.2 サポート・リソース

テキサス・インスツルメンツ E2E™ サポート・フォーラムは、エンジニアが検証済みの回答と設計に関するヒントをエキスパートから迅速かつ直接得ることができる場所です。既存の回答を検索したり、独自の質問をしたりすることで、設計で必要な支援を迅速に得ることができます。

リンクされているコンテンツは、各寄稿者により「現状のまま」提供されるものです。これらはテキサス・インスツルメンツの仕様を構成するものではなく、必ずしもテキサス・インスツルメンツの見解を反映したものではありません。テキサス・インスツルメンツの使用条件を参照してください。

### 8.3 Trademarks

テキサス・インスツルメンツ E2E™ is a trademark of Texas Instruments. すべての商標は、それぞれの所有者に帰属します。

# 8.4 静電気放電に関する注意事項



この IC は、ESD によって破損する可能性があります。テキサス・インスツルメンツは、IC を取り扱う際には常に適切な注意を払うことを推奨します。正しい取り扱いおよび設置手順に従わない場合、デバイスを破損するおそれがあります。

ESD による破損は、わずかな性能低下からデバイスの完全な故障まで多岐にわたります。精密な IC の場合、パラメータがわずかに変化するだけで公表されている仕様から外れる可能性があるため、破損が発生しやすくなっています。

### 8.5 用語集

テキサス・インスツルメンツ用語集 この用語集には、用語や略語の一覧および定義が記載されています。

### 9 Revision History

# Changes from Revision \* (March 2023) to Revision A (March 2024)

Page

# 10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

資料に関するフィードバック (ご意見やお問い合わせ) を送信 Copyright © 2024 Texas Instruments Incorporated

# 重要なお知らせと免責事項

テキサス・インスツルメンツは、技術データと信頼性データ (データシートを含みます)、設計リソース (リファレンス デザインを含みます)、アプリケーションや設計に関する各種アドバイス、Web ツール、安全性情報、その他のリソースを、欠陥が存在する可能性のある「現状のまま」提供しており、商品性および特定目的に対する適合性の黙示保証、第三者の知的財産権の非侵害保証を含むいかなる保証も、明示的または黙示的にかかわらず拒否します。

これらのリソースは、テキサス・インスツルメンツ製品を使用する設計の経験を積んだ開発者への提供を意図したものです。(1) お客様のアプリケーションに適した テキサス・インスツルメンツ製品の選定、(2) お客様のアプリケーションの設計、検証、試験、(3) お客様のアプリケーションに該当する各種規格や、その他のあらゆる安全性、セキュリティ、規制、または他の要件への確実な適合に関する責任を、お客様のみが単独で負うものとします。

上記の各種リソースは、予告なく変更される可能性があります。これらのリソースは、リソースで説明されているテキサス・インスツルメンツ製品を使用するアプリケーションの開発の目的でのみ、テキサス・インスツルメンツはその使用をお客様に許諾します。これらのリソースに関して、他の目的で複製することや掲載することは禁止されています。テキサス・インスツルメンツや第三者の知的財産権のライセンスが付与されている訳ではありません。お客様は、これらのリソースを自身で使用した結果発生するあらゆる申し立て、損害、費用、損失、責任について、テキサス・インスツルメンツおよびその代理人を完全に補償するものとし、テキサス・インスツルメンツは一切の責任を拒否します。

テキサス・インスツルメンツの製品は、テキサス・インスツルメンツの販売条件、または ti.com やかかる テキサス・インスツルメンツ製品の関連資料などのいずれかを通じて提供する適用可能な条項の下で提供されています。テキサス・インスツルメンツがこれらのリソースを提供することは、適用されるテキサス・インスツルメンツの保証または他の保証の放棄の拡大や変更を意味するものではありません。

お客様がいかなる追加条項または代替条項を提案した場合でも、テキサス・インスツルメンツはそれらに異議を唱え、拒否します。

郵送先住所: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2024, Texas Instruments Incorporated www.ti.com 23-May-2025

### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	<b>RoHS</b> (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
						(4)	(5)		
TMAG6180EDGKRQ1	Active	Production	VSSOP (DGK)   8	2500   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 150	6180
TMAG6180EDGKRQ1.B	Active	Production	VSSOP (DGK)   8	2500   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 150	6180

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

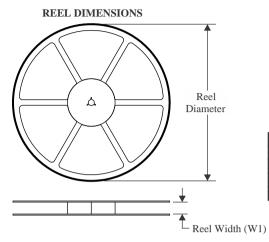
<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

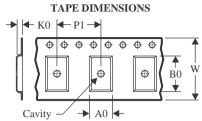
<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 5-Nov-2024

# TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

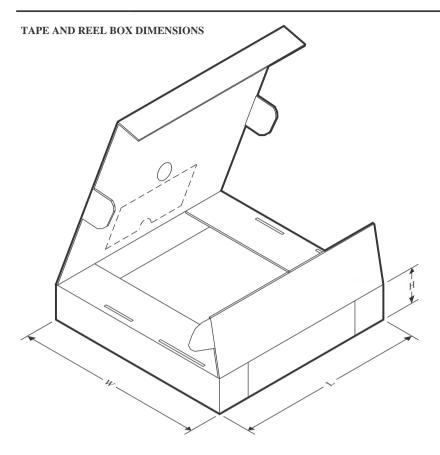


### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TMAG6180EDGKRQ1	VSSOP	DGK	8	2500	330.0	12.4	5.25	3.35	1.25	8.0	12.0	Q1

**PACKAGE MATERIALS INFORMATION** 

www.ti.com 5-Nov-2024



# \*All dimensions are nominal

	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
I	TMAG6180EDGKRQ1	VSSOP	DGK	8	2500	366.0	364.0	50.0	



SMALL OUTLINE PACKAGE



### NOTES:

PowerPAD is a trademark of Texas Instruments.

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-187.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
- 8. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.
- 9. Size of metal pad may vary due to creepage requirement.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 11. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 12. Board assembly site may have different recommendations for stencil design.



# 重要なお知らせと免責事項

テキサス・インスツルメンツは、技術データと信頼性データ (データシートを含みます)、設計リソース (リファレンス デザインを含みます)、アプリケーションや設計に関する各種アドバイス、Web ツール、安全性情報、その他のリソースを、欠陥が存在する可能性のある「現状のまま」提供しており、商品性および特定目的に対する適合性の黙示保証、第三者の知的財産権の非侵害保証を含むいかなる保証も、明示的または黙示的にかかわらず拒否します。

これらのリソースは、 テキサス・インスツルメンツ製品を使用する設計の経験を積んだ開発者への提供を意図したものです。(1) お客様のアプリケーションに適した テキサス・インスツルメンツ製品の選定、(2) お客様のアプリケーションに該当する各種規格や、その他のあらゆる安全性、セキュリティ、規制、または他の要件への確実な適合に関する責任を、お客様のみが単独で負うものとします。

上記の各種リソースは、予告なく変更される可能性があります。これらのリソースは、リソースで説明されている テキサス・インスツルメンツ製品を使用するアプリケーションの開発の目的でのみ、 テキサス・インスツルメンツはその使用をお客様に許諾します。これらのリソースに関して、他の目的で複製することや掲載することは禁止されています。 テキサス・インスツルメンツや第三者の知的財産権のライセンスが付与されている訳ではありません。お客様は、これらのリソースを自身で使用した結果発生するあらゆる申し立て、損害、費用、損失、責任について、 テキサス・インスツルメンツおよびその代理人を完全に補償するものとし、 テキサス・インスツルメンツは一切の責任を拒否します。

テキサス・インスツルメンツの製品は、 テキサス・インスツルメンツの販売条件、または ti.com やかかる テキサス・インスツルメンツ 製品の関連資料などのいずれかを通じて提供する適用可能な条項の下で提供されています。 テキサス・インスツルメンツがこれらのリソ 一スを提供することは、適用される テキサス・インスツルメンツの保証または他の保証の放棄の拡大や変更を意味するものではありません。

お客様がいかなる追加条項または代替条項を提案した場合でも、 テキサス・インスツルメンツはそれらに異議を唱え、拒否します。

郵送先住所: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2025, Texas Instruments Incorporated